

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.



FDP2710 N-Channel PowerTrench[®] MOSFET 250 V, 50 A, 42.5 mΩ

Features

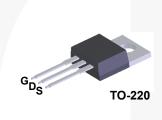
- $R_{DS(on)}$ = 36.3 m Ω (Typ.)@ V_{GS} = 10 V, I_D = 25 A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handing Capability
- RoHS Compliant

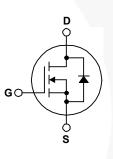
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Consumer Appliances
- Synchronous Rectification





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter		FDP2710	Unit
V _{DS}	Drain-Source Voltage		rain-Source Voltage 250		V
V _{GS}	Gate-Source voltage		± 30	V	
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$) - Continuous ($T_C = 100^{\circ}C$)		50 31.3	A A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	See Figure 9	A
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		(Note 2)	145	mJ
dv/dt	Peak Diode Recovery dv/dt (No		(Note 3)	4.5	V/ns
P _D	Power Dissipation (T _C = 25°C) - Derate above 25°C		260 2.1	W W/°C	
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
Τ _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

Symbol	Parameter	FDP2710	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.48	°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

www.fairchildsemi.com

October 2013

Device Marking		Device	ce Package Reel Size 1		Тар	Tape Width		Quantity		
		TO	D-220 Tube		N/A		50 units			
Electrica	l Chai	racteristics T _c	_C = 25°C unle	ess otherwis	e noted					
Symbol		Parameter		Conditions		Min	Тур	Max	Unit	
Off Characte	eristics									
BV _{DSS} [Drain-Sou	urce Breakdown Volta	ige	$V_{GS} = 0V, I_D = 250\mu A, T_J = 25^{\circ}C$		250			V	
000	BVDSS Breakdown Voltage Temperature			I _D = 250μA, Referenced to 25°C			0.25		V/∘C	
I _{DSS} Z	Zero Gate Voltage Drain Current		nt	$V_{DS} = 250V, V_{GS} = 0V$ $V_{DS} = 250V, V_{GS} = 0V, T_{C} = 125^{\circ}C$				10 500	μΑ μΑ	
I _{GSSF} (Gate-Bod	y Leakage Current, F	orward	V _{GS} = 30\	/, V _{DS} = 0V				100	nA
I _{GSSR} (Gate-Bod	y Leakage Current, R	Reverse	$V_{GS} = -30V, V_{DS} = 0V$				-100	nA	
On Characte	ristics									
V _{GS(th)} (Gate Threshold Voltage			V _{DS} = V _{GS}	_s , I _D = 250μA		3.0	4.0	5.0	V
R _{DS(on)} S	Static Drain-Source On-Resistance		ance	V _{GS} = 10V, I _D = 25A			36.3	42.5	mΩ	
g _{FS} F	Forward Transconductance			V _{DS} = 10V	/, I _D = 25Α			63		S
Dynamic Cha	aracteris	tics								
C _{iss} I	Input Capacitance						5470	7280	pF	
C _{oss} (Output Capacitance Reverse Transfer Capacitance			V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz			426	570	pF	
							97	146	pF	
Switching Cl	haracteri	stics								
t _{d(on)}	Turn-On Delay Time Turn-On Rise Time						80	170	ns	
t _r 1				V _{DD} = 125V, I _D = 50A V _{GS} = 10V, R _{GEN} = 25Ω				252	515	ns
t _{d(off)}	Turn-Off [Delay Time						112	235	ns
t _f 1	Turn-Off F	all Time				(Note 4)		154	320	ns
Q _g 1	Total Gate	e Charge		$V_{DS} = 125V, I_D = 50A$ $V_{GS} = 10V$ (Note 4)				78	101	nC
Q _{gs} (Gate-Sou	rce Charge						34	,	nC
Q _{gd} (Gate-Drai	in Charge				(Note 4)	/	18		nC
Drain-Source	e Diode (Characteristics and	Maximum	Ratings						
I _S Maximum Continuous Drain-Source Dio			ource Diode	e Forward	Current				50	Α
	Maximum Pulsed Drain-Source Diode F		e Diode Foi	orward Current				150	Α	
V _{SD} [Drain-Sou	urce Diode Forward V	oltage	V _{GS} = 0V, I _S = 50A				1.2	V	
t _{rr} F	Reverse I	Recovery Time		V _{GS} = 0V,				163		ns
	Reverse I	Recovery Charge		$dI_F/dt = 100A/\mu s$				1.3		μC

Notes:

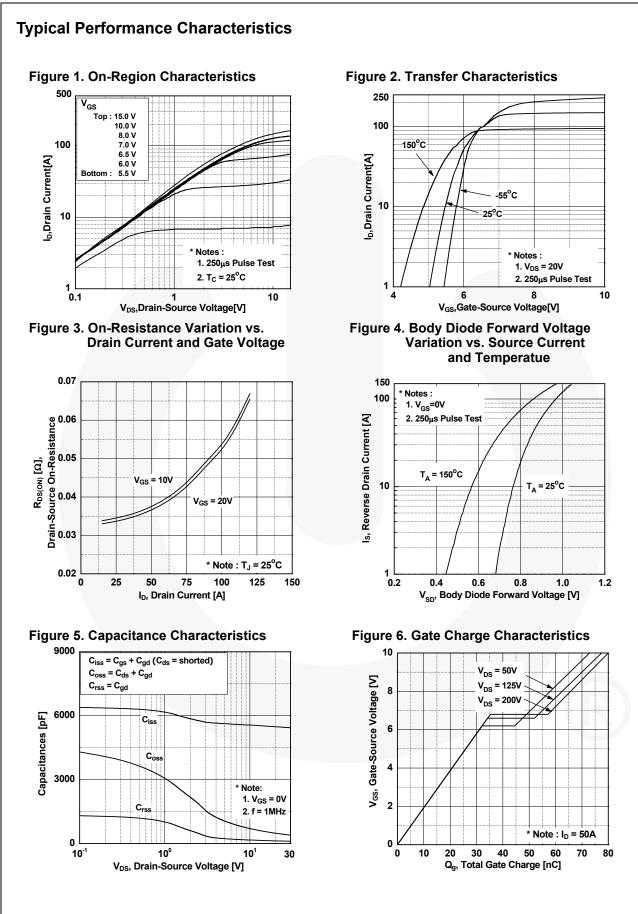
1. Repetitive Rating: Pulse width limited by maximum junction temperature

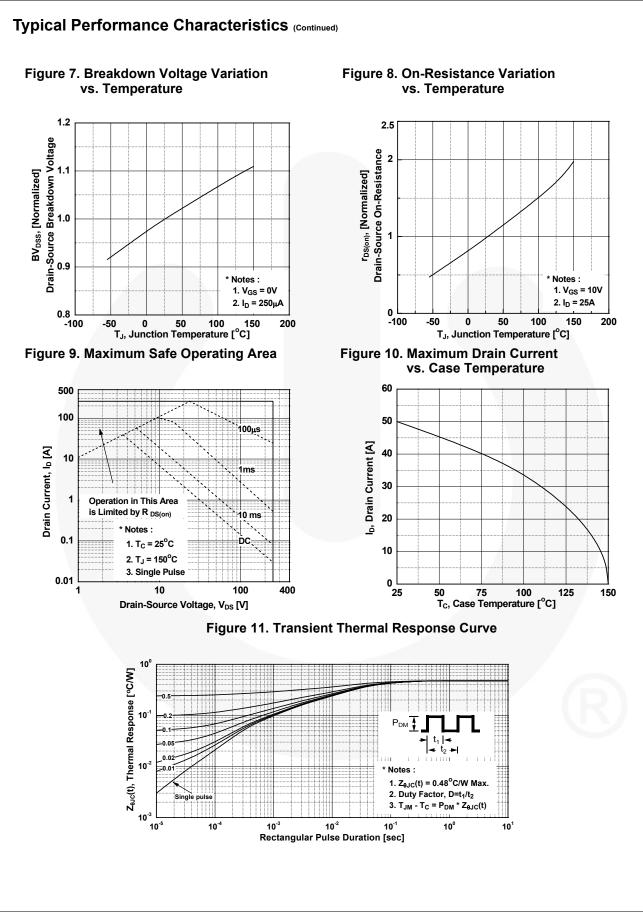
Package Marking and Ordering Information

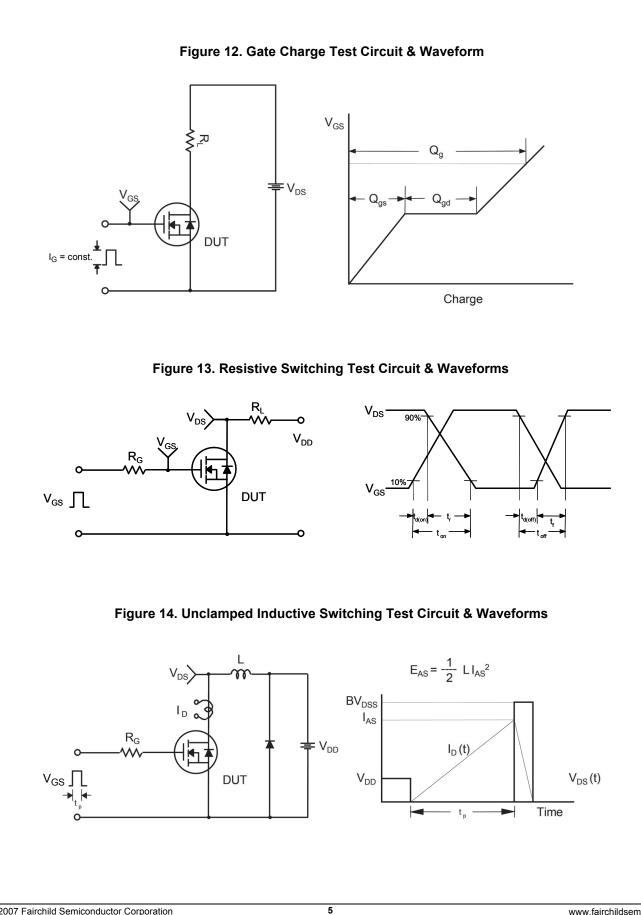
2. L = 1mH, I_{AS} = 17A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

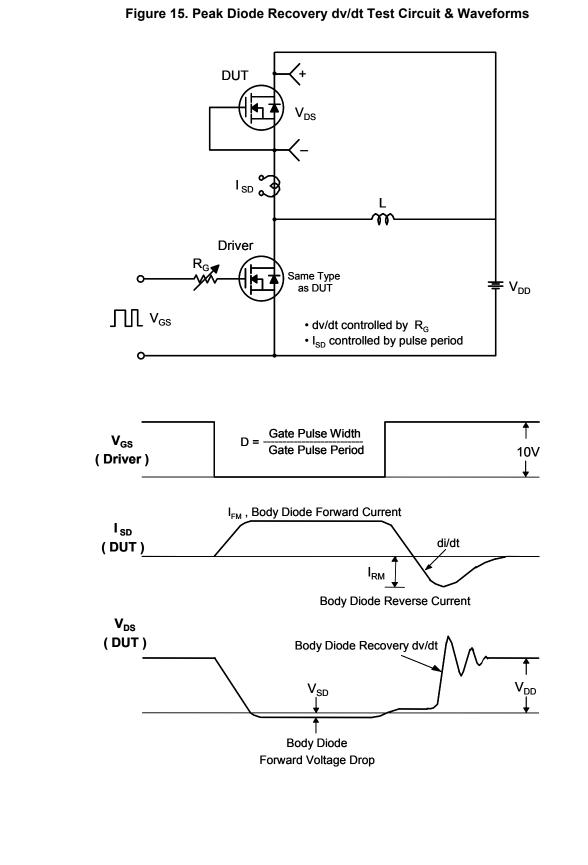
3. $I_{SD} \leq$ 50A, di/dt \leq 100A/µs, $V_{DD} \leq$ BV_{DSS}, Starting T_J = 25°C

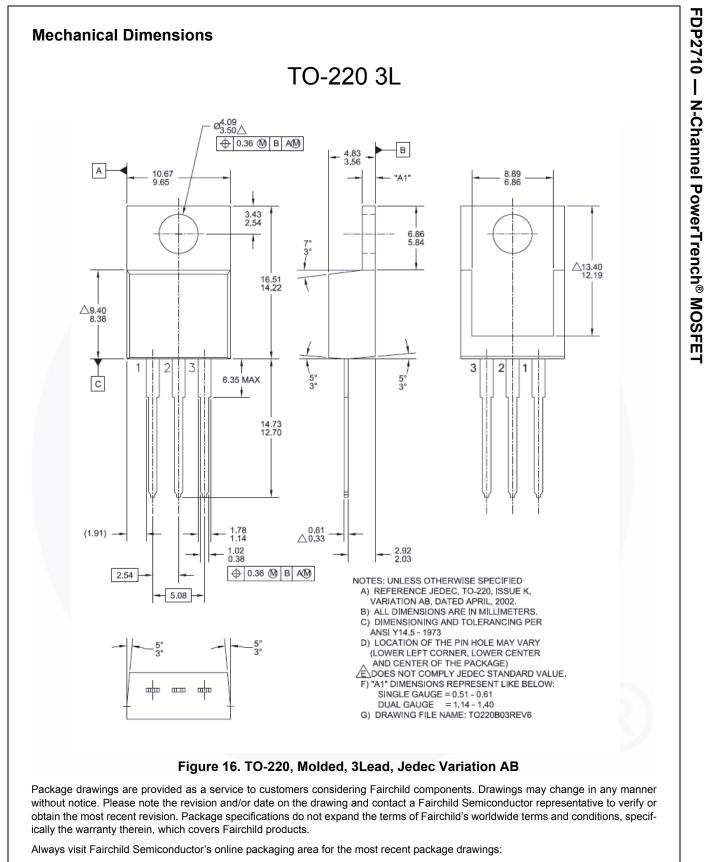
4. Essentially Independent of Operating Temperature Typical Characteristics











http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TT220-003

Dimension in Millimeters



SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™	F-PFS™	R	Sync-Lock™
AX-CAP [®] *	FRFET®		SYSTEM ®*
BitSiC™	Global Power Resource SM	PowerTrench [®]	GENERAL
Build it Now™	GreenBridge™	PowerXS™	TinyBoost [®]
CorePLUS™	Green FPS™	Programmable Active Droop™	TinyBuck [®]
CorePOWER™	Green FPS™ e-Series™	QFET®	TinyCalc™
CROSSVOLT™	G <i>max</i> ™	QS™	
CTL™	GTO™	Quiet Series™	TinyLogic [®] TINYOPTO™
Current Transfer Logic™	IntelliMAX™	RapidConfigure™	TinyPower™
DEUXPEED®	ISOPLANAR™	[™]	
Dual Cool™	Marking Small Speakers Sound Loude	r 🔾	TinyPWM™
EcoSPARK [®]	and Better™	Saving our world, 1mW/W/kW at a time™	TinyWire™ Trans CiO™
EfficentMax™	MegaBuck™	SignalWise™	TranSiC™
ESBC™	MIČROCOUPLER™	SmartMax™	TriFault Detect™
	MicroFET™	SMART START™	TRUECURRENT®*
	MicroPak™	Solutions for Your Success™	µSerDes™
Fairchild [®]	MicroPak2™	SPM®	\mathcal{M}
Fairchild Semiconductor [®]	MillerDrive ™	STEALTH™	<mark>∕ Ser</mark> Des"
FACT Quiet Series™	MotionMax™	SuperFET®	UHC [®]
FACT Quiet Series	mWSaver®	SuperSOT™-3	Ultra FRFET™
FACT®	OptoHiT™	SuperSOT™-6	UniFET™
FAST®	OPTOLOGIC®	SuperSOT™-8	VCX™
FastvCore™	OPTOPLANAR [®]	SupreMOS [®]	VisualMax™
FETBench™	OF TOT EANAR	SyncFET™	VoltagePlus™
FPS™		Synci Li m	XS™

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Term

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death a

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor: <u>FDP2710</u>